

江苏宏微科技股份有限公司  
IGBT 模块生命周期评价报告



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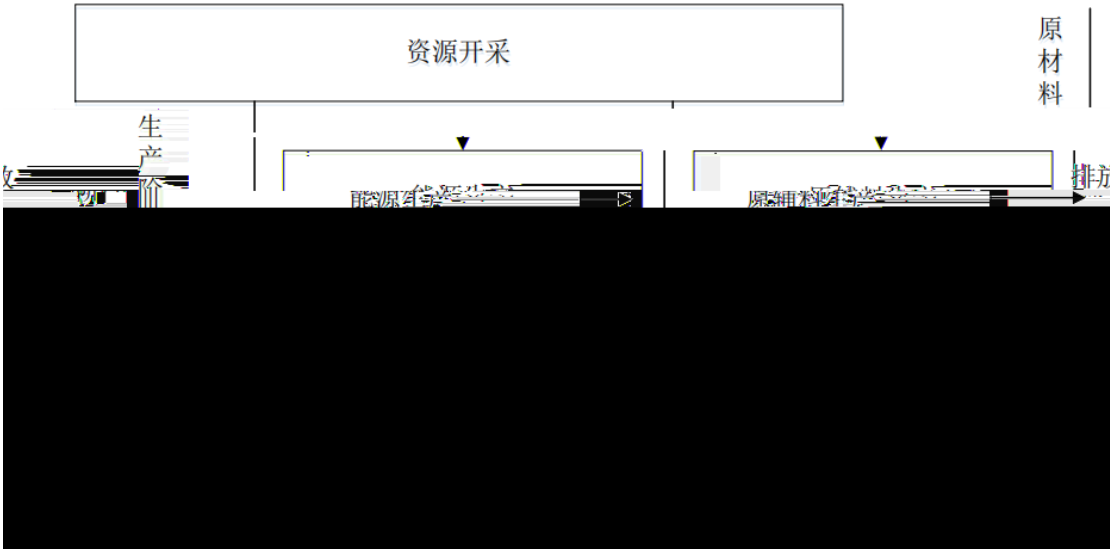
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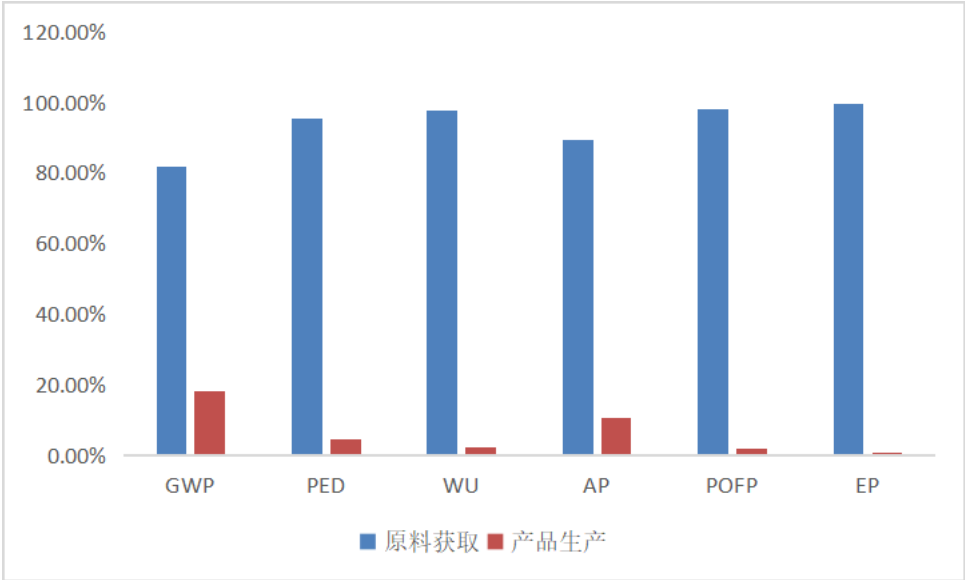
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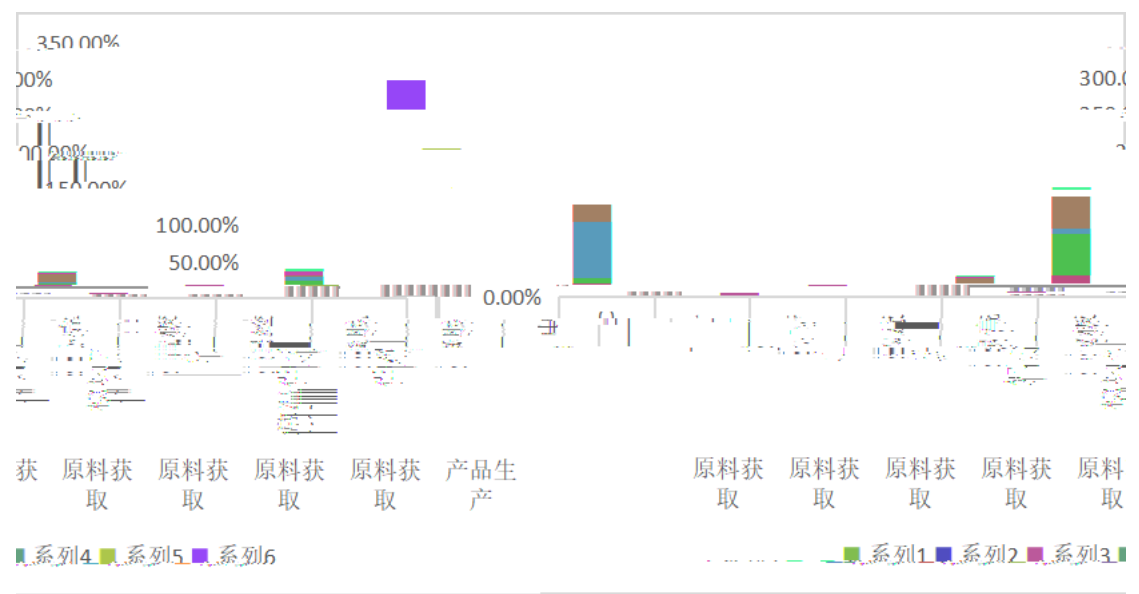
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物料清单 - 查看

新增保存提交审核关联查询业务操作前一后列表选项退出

创建组织江苏宏微科技股份有限公司

使用组织江苏宏微科技股份有限公司

审核BOM版本610902211V07

BOM简称

主产品

联副产品

其他

BOM分类标准BOM

BOM用途

BOM分组

物料名称IGBT模块

规格型号MMG50HD120XB6TC

物料属性自制

辅助属性

产品模型

描述

用量物料控制其他

子项明细

执行复制查找冻结列上移下移替代获取替代设置替代删除业务查询批量填充

物料代码物料名称子项规格型号子项物料属性单位类别子项单位单位换算子项单位单位换算

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| 1 | 420141010 | DBC+芯片+焊膏 |
| 2 | 101000091 | 铜底板       |
| 3 | 101100072 | 模块外壳      |
| 4 | 101200025 | 模块盖板      |
| 5 | 102600016 | 焊膏        |
| 6 | 102000001 | 铅丝        |
| 7 | 102300014 | 常温硅橡胶     |
| 8 | 102200009 | 硅凝胶       |
| 9 | 102200010 | 硅凝胶       |

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